

## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV1811DBVR	SOT-23	DBV	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1811DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1811LDBVR	SOT-23	DBV	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1811LDCKR	SC70	DCK	6	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1812DDFR	SOT-23-THIN	DDF	8	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLV1812DGKR	VSSOP	DGK	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLV1812DR	SOIC	D	8	3000	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLV1812DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TLV1812PWR	TSSOP	PW	8	3000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
TLV1814DR	SOIC	D	14	3000	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLV1814RTER	WQFN	RTE	16	5000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TLV1821DBVR	SOT-23	DBV	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1821DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1821LDBVR	SOT-23	DBV	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TLV1822DDFR	SOT-23-THIN	DDF	8	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV1822DGKR	VSSOP	DGK	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLV1822DR	SOIC	D	8	3000	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLV1822DSGR	WSO8	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TLV1822PWR	TSSOP	PW	8	3000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
TLV1824DR	SOIC	D	14	3000	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLV1824PWR	TSSOP	PW	14	3000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV1811DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TLV1811DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TLV1811LDBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TLV1811LDCKR	SC70	DCK	6	3000	180.0	180.0	18.0
TLV1812DDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
TLV1812DGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
TLV1812DR	SOIC	D	8	3000	356.0	356.0	35.0
TLV1812DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
TLV1812PWR	TSSOP	PW	8	3000	356.0	356.0	35.0
TLV1814DR	SOIC	D	14	3000	356.0	356.0	35.0
TLV1814RTER	WQFN	RTE	16	5000	367.0	367.0	35.0
TLV1821DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TLV1821DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TLV1821LDBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TLV1822DDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
TLV1822DGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
TLV1822DR	SOIC	D	8	3000	356.0	356.0	35.0
TLV1822DSGR	WSON	DSG	8	3000	210.0	185.0	35.0

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV1822PWR	TSSOP	PW	8	3000	356.0	356.0	35.0
TLV1824DR	SOIC	D	14	3000	356.0	356.0	35.0
TLV1824PWR	TSSOP	PW	14	3000	356.0	356.0	35.0